

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	12	("3770598" "4374709" "4376685" "4555315" "4673469").pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/23 13:27
L3	5	("3770598" "4374709" "4376685" "4555315" "4673469").pn.	US-PGPUB; USPAT	OR	ON	2006/08/23 15:04
L4	1	("4134803").pn.	US-PGPUB; USPAT	OR	ON	2006/08/23 15:09
L5	1	"4075248".pn.	US-PGPUB; USPAT	OR	ON	2006/08/23 14:01
L6	1	("2516412").pn.	US-PGPUB; USPAT	OR	ON	2006/08/23 14:01
L7	90	(\$2sulfosulfonate (\$2sulfo adj sulfonate))	US-PGPUB; USPAT	OR	ON	2006/08/23 14:11
L8	15	(\$2sulfosulfonate (\$2sulfo adj sulfonate)) and ("205" "204").clas.	US-PGPUB; USPAT	OR	ON	2006/08/23 14:32
L9	1	"3,725,220".pn.	US-PGPUB; USPAT	OR	ON	2006/08/23 14:41
L13	51	"3,267,010"	US-PGPUB; USPAT	OR	ON	2006/08/23 15:04
L14	1	"3,101,305".pn.	US-PGPUB; USPAT	OR	ON	2006/08/23 15:13
L15	264	acid and copper and (electroplating plating) and aldehyde	USOCR	OR	ON	2006/08/23 15:13
L16	272	acid and copper and (electroplating plating) and (aldehyde acetaldehyde)	USOCR	OR	ON	2006/08/23 15:13
L17	56	acid and copper and (electroplating plating) and (acetaldehyde)	USOCR	OR	ON	2006/08/23 15:39
L18	108	acid and copper and (electroplating plating) and (aldehyde acetaldehyde) and ("204" "205").clas.	USOCR	OR	ON	2006/08/23 15:21
L19	40	acid and copper and (electroplating plating) and (aldehyde acetaldehyde) and ("204" "205").clas. and (polysulfide disulfide sulfonate)	USOCR	OR	ON	2006/08/23 15:22
L20	23	("3682788").URPN.	USPAT	OR	ON	2006/08/23 15:35
L21	11	("3682788").URPN. and polysulfide	USPAT	OR	ON	2006/08/23 15:36
L22	0	("3682788").URPN. and polysulfide.ab.	USPAT	OR	ON	2006/08/23 15:36
L23	8	("3682788").URPN. and polysulfide and aldehyde	USPAT	OR	ON	2006/08/23 15:36

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L24	272	acid and copper and (electroplating plating) and (aldehyde acetaldehyde butanal ethanal)	USOCR	OR	ON	2006/08/23 15:41
L25	22	acid and copper.ti. and (electroplating plating) and (aldehyde acetaldehyde butanal ethanal)	USOCR	OR	ON	2006/08/23 15:52
L26	212	acid and (electroplating plating) and (aldehyde acetaldehyde butanal ethanal) same (brighten\$3 level\$4 inhibit\$3)	USOCR	OR	ON	2006/08/23 15:55
L27	111	L26 and copper	USOCR	OR	ON	2006/08/23 15:53
L28	72	acid and (electroplating plating) and (aldehyde acetaldehyde butanal ethanal) same (brighten\$3 level\$4 inhibit\$3) and copper not condensat\$3	USOCR	OR	ON	2006/08/23 16:05
L29	157	acid and (electroplating plating) and (aldehyde acetaldehyde butanal ethanal) same (brighten\$3 level\$4 inhibit\$3) and copper not condensat\$3	USPAT	OR	ON	2006/08/23 16:05
L30	60	acid and (electroplating plating) and (aldehyde acetaldehyde butanal ethanal) same (brighten\$3 level\$4 inhibit\$3) and copper not condensat\$3 and ("204" "205").clas.	USPAT	OR	ON	2006/08/23 16:05
L31	35	aliphatic adj aldehyde and copper with electroplat\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/23 16:30
L32	23	aliphatic adj aldehyde and copper with electroplat\$	USPAT; USOCR	OR	ON	2006/08/23 16:31